

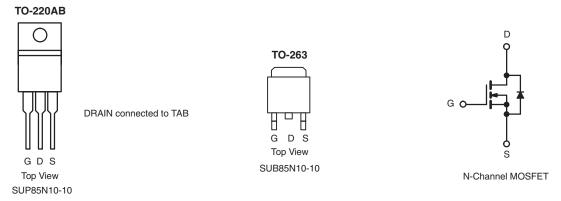
N-Channel 100-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	I _D (A)			
100	0.0105 at V _{GS} = 10 V	058		
100	0.012 at V _{GS} = 4.5 V	- 85 ^a		

FEATURES

- TrenchFET® Power MOSFET
- 175 °C Maximum Junction Temperature
- Compliant to RoHS Directive 2002/95/EC





ORDERING INFORMATION				
Package	Lead (Pb)-free			
TO-220AB	SUP85N10-10-E3			
TO-263	SUB85N10-10-E3			

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted					
Parameter			Limit	Unit	
Drain-Source Voltage			100		
Gate-Source Voltage		V_{GS}	± 20	V	
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	I_	85 ^a		
	T _C = 125 °C	- I _D	60 ^a		
Pulsed Drain Current		I _{DM}	240	Α	
Avalanche Current	alanche Current L = 0.1 mH		75		
Single Pulse Avalanche Energy ^b	L = 0.1 mm	E _{AS}	280	mJ	
Mariana Barra Birata di ab	T _C = 25 °C (TO-220AB and TO-263)	P _D	250 ^c	W	
Maximum Power Dissipation ^b	T _A = 25 °C (TO-263) ^d	' D	3.75	l vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Limit	Unit	
Junction-to-Ambient	PCB Mount (TO-263) ^d	- R _{thJA}	40	°C/W	
Junction-to-Ambient	Free Air (TO-220AB)		62.5		
Junction-to-Case		R _{thJC}	0.6		

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve fo voltage derating.
- d. When mounted on 1" square PCB (FR-4 material).

SUP85N10-10, SUB85N10-10

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SPECIFICATIONS T _J = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	V _{GS} = 0 V, I _D = 250 μA	100			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = 100 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C			250	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
		V _{GS} = 10 V, I _D = 30 A		0.0085	0.0105	Ω	
	D	V _{GS} = 4.5 V, I _D = 20 A		0.010	0.012		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125 ^{\circ}\text{C}$			0.017		
		$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 175 ^{\circ}\text{C}$			0.022		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S	
Dynamic ^b			•	•	•		
Input Capacitance	C _{iss}			6550		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		665			
Reverse Transfer Capacitance	C _{rss}			265			
Total Gate Charge ^c	Qg			105	160	nC	
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$		17			
Gate-Drain Charge ^c	Q _{gd}			23		-	
Turn-On Delay Time ^c	t _{d(on)}			12	25		
Rise Time ^c	t _r	V_{DD} = 50 V, R_L = 0.6 Ω		90	135		
Turn-Off DelayTime ^c	t _{d(off)}	$I_D \cong 85 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		55	85	ns	
Fall Time ^c	t _f			130	195		
Source-Drain Diode Ratings and Characteristics $T_C = 25 {}^{\circ}C^b$							
Continuous Current	I _S				85	۸	
Pulsed Current	I _{SM}				240	Α	
Forward Voltage ^a	V _{SD}	I _F = 85 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			85	140	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, dI/dt = 100 A/μs		4.5	7	Α	
Reverse Recovery Charge	Q _{rr}	1		0.17	0.35	μC	

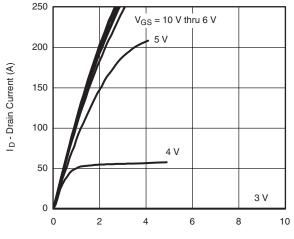
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

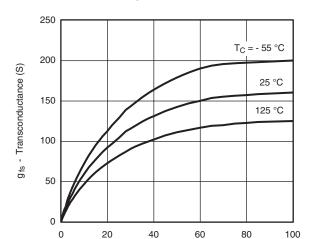


TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted

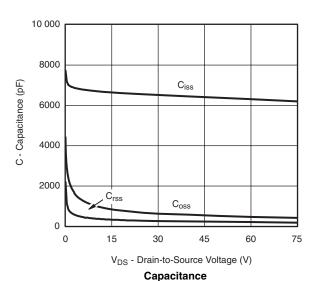


V_{DS} - Drain-to-Source Voltage (V)

Output Characteristics

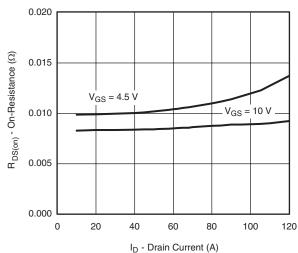


I_D - Drain Current (A) **Transconductance**

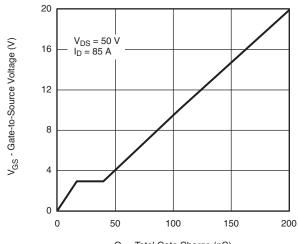


(b) 150 T_C = 125 °C T_C = 1

V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics**



On-Resistance vs. Drain Current



Q_g - Total Gate Charge (nC)

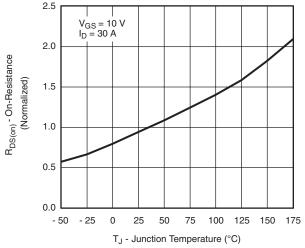
Gate Charge

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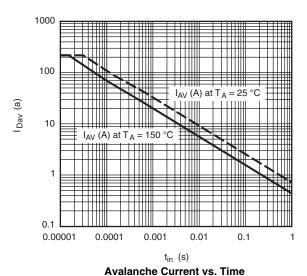
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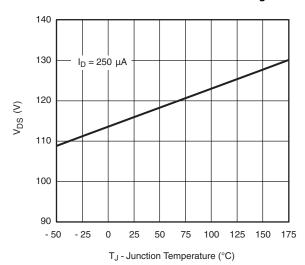


On-Resistance vs. Junction Temperature



T_J = 150 °C T_J = 25 °C T_J

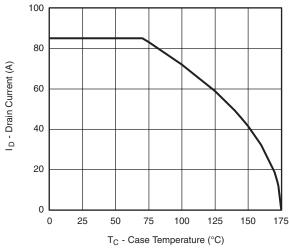
Source-Drain Diode Forward Voltage



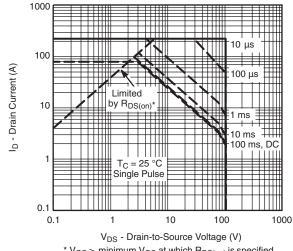
T_J - Drain-Source Breakdown vs. Junction-Temperature



THERMAL RATINGS

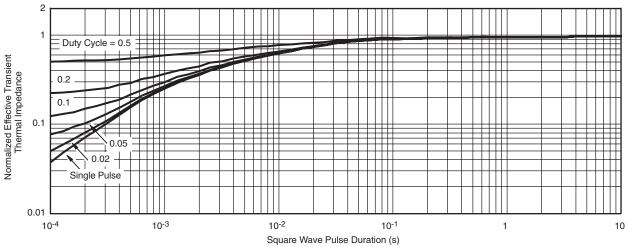


Maximum Avalanche and Drain Current vs. Case Temperature



 * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified





Normalized Thermal Transient Impedance, Junction-to-Case

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TO-220AB



	D2

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
D2	12.19	12.70	0.480	0.500
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØΡ	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471				

Note

 $^{^{\}star}$ M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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